



(社)日本半導体製造装置協会

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2008年2月度BBレシオ (Book-to-Bill) (SEAJ速報値) 日本製半導体製造装置 (3ヶ月平均)

注意: データは3ヵ月移動平均です。

次回予定: SEAJ 3月度BBレシオ 4/17 16:00 SEAJ ホームページアップ予定

日本製の半導体製造装置の2008年2月度のBBレシオは0.85

東京 2008年3月18日 - 日本半導体製造装置協会が18日に発表した2月度の半導体製造装置速報値によると日本製装置(輸出を含む)の受注額は**112,493**百万円(3ヶ月移動平均)、BBレシオは**0.85**だった。BBレシオ0.85は100円で販売したのに対し85円の新たな受注があったことを示す。

受注額は前月比**11.0%**減(2008年1月度確定値は**126,424**百万円)、前年同月比**42.5%**減(2007年2月度は**195,575**百万円)の**112,493**百万円だった。

販売額は前月比**4.3%**減(2008年1月度確定値は**138,219**百万円)、前年同月比**11.6%**減(2007年2月度は**149,632**百万円)の**132,322**百万円だった。

※BBレシオの算出に当たっては、受注高、販売高の3ヶ月移動平均データを使用。単位:百万円

	販売 (3ヶ月平均)	受注 (3ヶ月平均)	BBレシオ
2007/9	176,126	129,323	0.73
2007/10	161,892	127,056	0.78
2007/11	149,315	129,901	0.87
2007/12	134,206	132,215	0.99
2008/1(確定値)	138,219	126,424	0.91
2008/2(暫定値)	132,322	112,493	0.85

本データは速報値(3ヶ月移動平均)です。確定値とは多少差異が生じる場合がありますのでご利用に際してはご注意ください。

なおSEMIは北米製の半導体製造装置のBBレシオ(3ヶ月移動平均の受注・販売比率)の速報を公表しています。

Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

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February 2008 Book-to-Bill Ratio (Express Report)

Japan-based Semiconductor Manufacturing Equipment (3 Month Average)

Note : All data is based on three month average numbers.

Mark your calendars. The March Report SEAJ's Web site update is scheduled on Thursday, 17th April approximately 4:00.P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts February 2008 Book-to-Bill Ratio of 0.85

Tokyo Japan., March 18, 2008 -- JAPAN-based manufacturers of semiconductor equipment posted ¥ 112,493 million in orders in February 2008 (three-month average basis) and a BB Ratio of 0.85 according to the February 2008 BB Ratio published today by SEAJ. A book-to-bill of 0.85 means that ¥ 85 worth of new orders was received for every ¥100 of product billed for the month.

The three-month average of worldwide bookings in February 2008 was ¥ 112,493 million. The bookings figure is 11.0 percent down the final January 2008 level of ¥ 126,424 million and 42.5 percent down the ¥ 195,575 million in orders posted in February 2007.

The three-month average of worldwide billings in February 2008 was 132,322 million. The billings figure is 4.3 percent down the final January 2008 level of ¥ 138,219 million and 11.6 percent down the February 2007 billings level of ¥ 149,632 million. The SEAJ book-to-bill is a ratio of three-month moving average bookings to three-month moving average billings for the Japanese semiconductor equipment industry. Billings and bookings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Bookings (Three-month avg.)	Book-to-Bill
September 2007	176,126	129,323	0.73
October 2007	161,892	127,056	0.78
November 2007	149,315	129,901	0.87
December 2007	134,206	132,215	0.99
January 2008(Final)	138,219	126,424	0.91
February 2008(prelim)	132,322	112,493	0.85

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Book-to-Bill Ratio published by SEAJ that tracks billings and bookings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings and orders of the chips themselves.

SEMI is released North American Semiconductor Manufacturing Equipment /Book-to-Bill Ratio(3 months Average) on Website. Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

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